

November 2013

FQP3P20

P-Channel QFET® MOSFET

-200 V, -2.8 A, 2.7 Ω

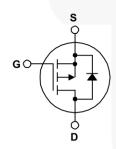
Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance • Low Crss (Typ 7.5 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, • 100% Avalanche Tested DC motor control, and variable switching power applications.

Features

- -2.8 A, -200 V, $R_{DS(on)}$ = 2.7 Ω (Max.) @ V_{GS} = -10 V, $I_D = -1.4 A$
- Low Gate Charge (Typ. 6 nC)





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQP3P20	Unit
V _{DSS}	Drain-Source Voltage		-200	V
Ь	Drain Current - Continuous (T _C = 25°C)		-2.8	А
	- Continuous (T _C = 100°C)		-1.77	А
I _{DM}	Drain Current - Pulsed	(Note 1)	-11.2	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy (N		150	mJ
I _{AR}	Avalanche Current	(Note 1)	-2.8	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		5.2	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		-5.5	V/ns
P _D	Power Dissipation (T _C = 25°C)		52	W
	- Derate above 25°C		0.42	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQP3P20	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.4	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

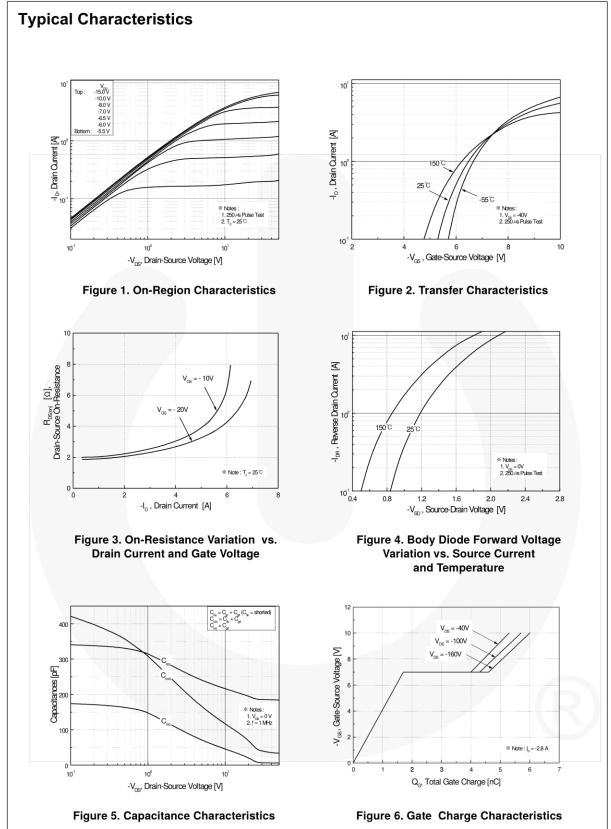
Package Marking and Ordering Information

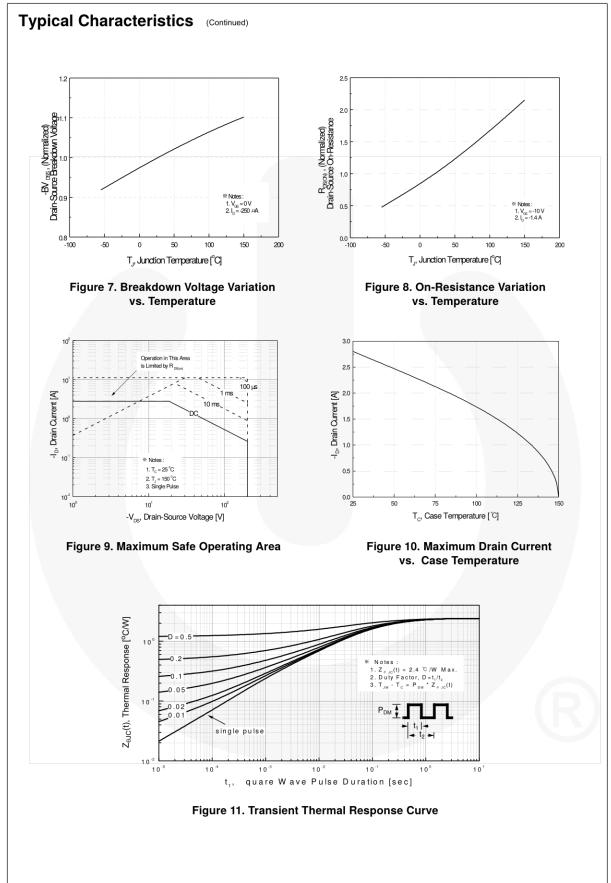
Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQP3P20	FQP3P20	TO-220	Tube	N/A	N/A	50 units

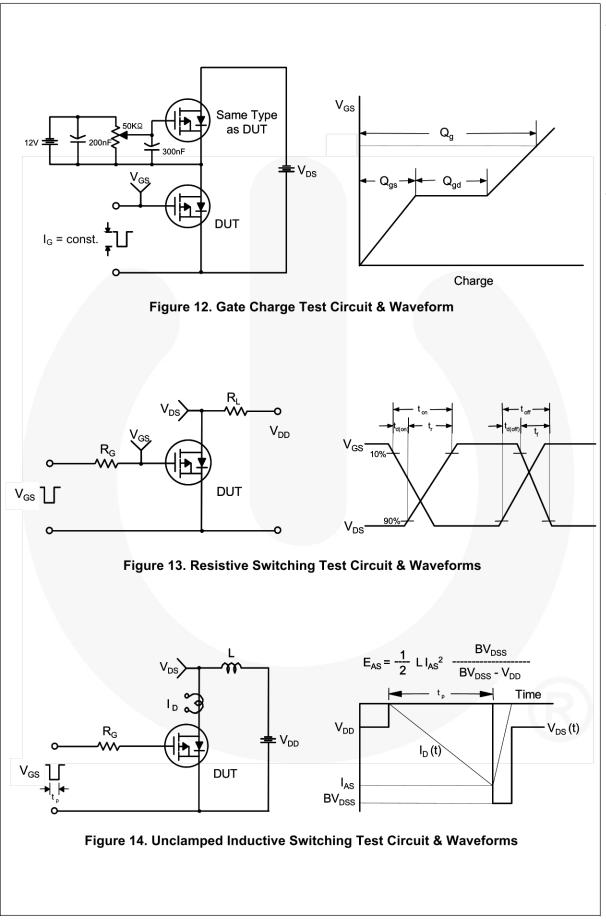
Electrical Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Uni
Off Cha	aracteristics					
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V, I}_{D} = -250 \mu\text{A}$	-200			V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = -250 μA, Referenced to 25°C		-0.18		V/°(
I _{DSS}	Zees Code Valtages Busin Comment	V _{DS} = -200 V, V _{GS} = 0 V			-1	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = -160 V, T _C = 125°C			-10	μА
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = -30 V, V _{DS} = 0 V			-100	nΑ
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V			100	nΑ
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	-3.0		-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -1.4 A		2.06	2.7	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -40 V, I _D = -1.4 A		1.23		S
	ic Characteristics			400	0.00	
C _{iss}	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$	\	190	250	pF
Coss	Output Capacitance	f = 1.0 MHz		45	60	pF
C _{rss}	Reverse Transfer Capacitance			7.5	10	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V 100 V I 28 A		8.5	25	ns
t _r	Turn-On Rise Time	$V_{DD} = -100 \text{ V}, I_{D} = -2.8 \text{ A},$ $R_{G} = 25 \Omega$		35	80	ns
t _{d(off)}	Turn-Off Delay Time			12	35	ns
t _f	Turn-Off Fall Time	(Note 4)		25	60	ns
Q_g	Total Gate Charge	V _{DS} = -160 V, I _D = -2.8 A,		6.0	8.0	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		1.7		nC
Q_{gd}	Gate-Drain Charge	(Note 4)		2.9		nC
	D: 1 01 1 1 1					
	Source Diode Characteristics at				2.0	Λ.
l _S	Maximum Continuous Drain-Source Diode Forward Current				-2.8	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				-11.2	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -2.8 A		400	-5.0	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_S = -2.8 \text{ A,}$		100	-	ns
Q_{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs		0.34		μC

- 1. Repetitive rating : pulse-width limited by maximum junction temperature.
- 2. L = 29 mH, I_{AS} = 2.8 A, V_{DD} = -50 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} \leq -2.8 A, di/dt \leq 300 A/µs , V_{DD} \leq BV_{DSS} starting T_J = 25°C. 4. Essentially independent of operating temperature.







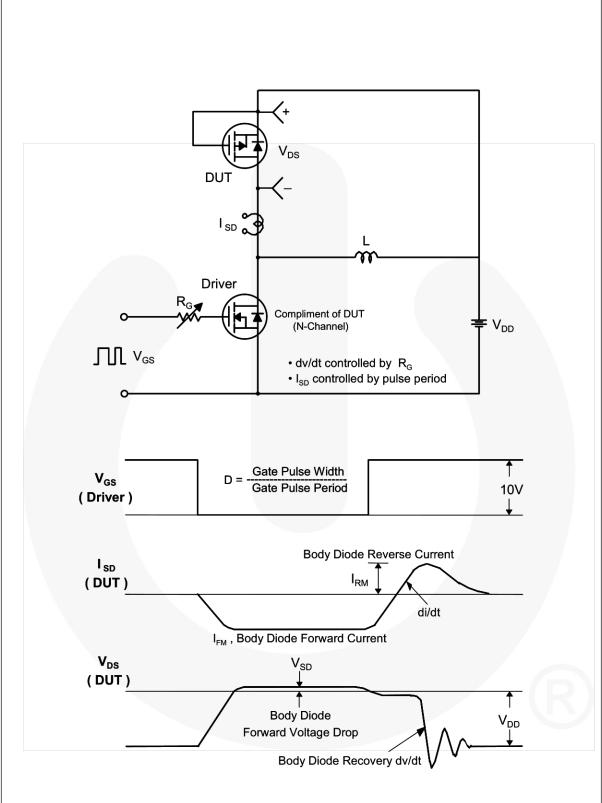


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

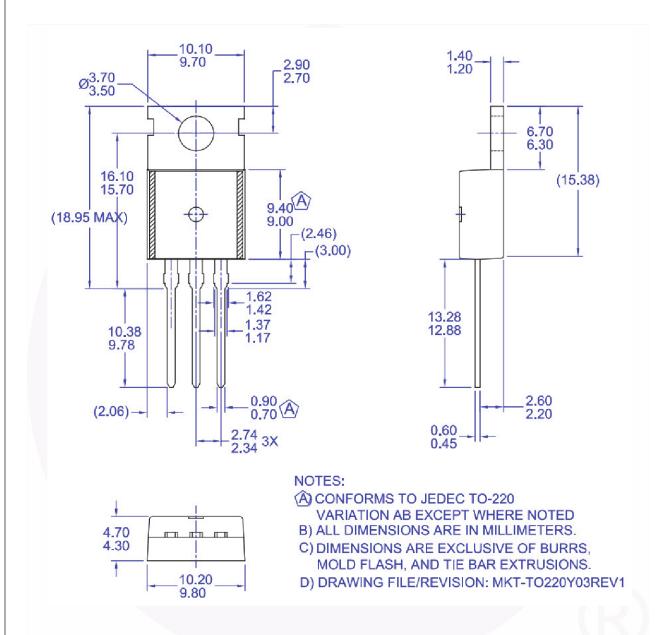


Figure 16. TO220, Molded, 3-Lead, Jedec Variation AB

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Rev. 166